**ADS7820** 





# 12-Bit 10μs Sampling CMOS ANALOG-to-DIGITAL CONVERTER

### **FEATURES**

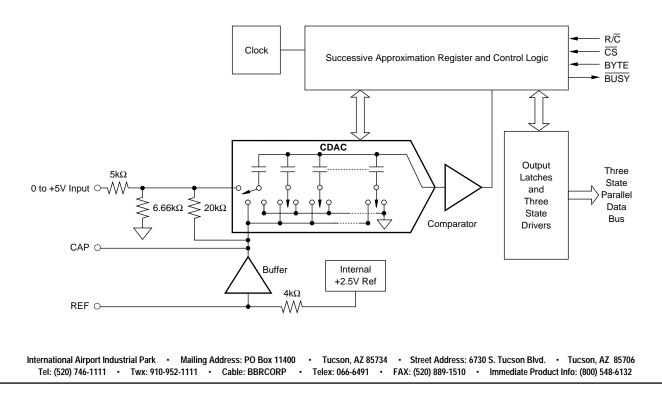
- 100kHz min SAMPLING RATE
- 0 to +5V INPUT RANGE
- 72dB min SINAD WITH 45kHz INPUT
- $\pm 1/2$  LSB max INL AND DNL
- SINGLE +5V SUPPLY OPERATION
- PIN-COMPATIBLE WITH 16-BIT ADS7821
- USES INTERNAL OR EXTERNAL REFERENCE
- COMPLETE WITH S/H, REF, CLOCK, ETC.
- FULL PARALLEL DATA OUTPUT
- 100mW max POWER DISSIPATION
- 28-PIN 0.3" PLASTIC DIP AND SOIC

## DESCRIPTION

The ADS7820 is a complete 12-bit sampling A/D using state-of-the-art CMOS structures. It contains a complete 12-bit, capacitor-based SAR A/D with S/H, reference, clock, interface for microprocessor use, and three-state output drivers.

The ADS7820 is specified at a 100kHz sampling rate, and guaranteed over the full temperature range. Laser-trimmed scaling resistors provide a 0 to +5V input range, with power dissipation under 100mW.

The 28-pin ADS7820 is available in a plastic 0.3" DIP and in an SOIC, both fully specified for operation over the industrial  $-40^{\circ}$ C to  $+85^{\circ}$ C range.



# SPECIFICATIONS

#### ELECTRICAL

 $T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ } \text{f}_{S} = 100 \text{kHz}, \text{ } \text{V}_{\text{DIG}} = \text{V}_{\text{ANA}} = +5 \text{V}, \text{ using internal reference, unless otherwise specified}.$ 

|   |  |                | ADS7820P/U                                |   |                            | ADS7820PB/UB      |   |   |
|---|--|----------------|---|---|----------------------------|-------------------|---|---|
| PARAMETER   | CONDITIONS   | MIN            | MIN TYP MAX                               |   | MIN                        | TYP               | MAX   | UNITS   |
| RESOLUTION  |  |                |   | 12  |                            |                   | *   | Bits  |
| ANALOG INPUT<br>Voltage Ranges<br>Impedance<br>Capacitance  |  |                | 0 to +5<br>10<br>35                       |   |                            | * *               |   | V<br>kΩ<br>pF   |
| THROUGHPUT SPEED<br>Conversion Time<br>Complete Cycle<br>Throughput Rate  | Acquire and Convert  | 100            | 5.7                                       | 8<br>10   | *                          | *                 | *   | μs<br>μs<br>kHz   |
| DC ACCURACY<br>Integral Linearity Error<br>Differential Linearity Error<br>No Missing Codes<br>Transition Noise <sup>(2)</sup><br>Full Scale Error Orift<br>Full Scale Error Drift<br>Full Scale Error Drift<br>Offset Error<br>Offset Error Drift<br>Power Supply Sensitivity<br>$(V_{DIG} = V_{ANA} = V_D)$ | Ext. 2.5000V Ref<br>Ext. 2.5000V Ref<br>+4.75V < V <sub>D</sub> < +5.25V   |                | Guaranteec<br>0.1<br>±7<br>±2<br>±2<br>±2 | $\pm 1.0$<br>$\pm 1.0$<br>$\pm 0.5$<br>$\pm 0.5$<br>$\pm 8$<br>$\pm 0.75$ |                            | *<br>*<br>±5<br>* | $\pm 0.5 \\ \pm 0.5 \\ \pm 0.25 \\ \pm 0.25 \\ \pm 4 \\ \pm 0.5 \\$ | LSB <sup>(1)</sup><br>LSB<br>Bits<br>LSB<br>%<br>ppm/°C<br>%<br>ppm/°C<br>LSB |
| AC ACCURACY<br>Spurious-Free Dynamic Range<br>Total Harmonic Distortion<br>Signal-to-(Noise+Distortion)<br>Signal-to-Noise<br>Full-Power Bandwidth <sup>(6)</sup>   | $\begin{array}{l} f_{\rm IN}=45 \rm kHz\\ f_{\rm IN}=45 \rm kHz\\ f_{\rm IN}=45 \rm kHz\\ f_{\rm IN}=45 \rm kHz\\ \end{array}$         | 80<br>70<br>70 | 250                                       | -80   | *<br>72<br>72              | *                 | *   | dB <sup>(5)</sup><br>dB<br>dB<br>dB<br>kHz                                    |
| SAMPLING DYNAMICS<br>Aperture Delay<br>Transient Response<br>Overvoltage Recovery <sup>(7)</sup>  | FS Step  |                | 40  | 2   |                            | *                 | *   | ns<br>μs<br>ns  |
| REFERENCE<br>Internal Reference Voltage<br>Internal Reference Source Current  |  | 2.48           | 2.5<br>1                                  | 2.52  | *                          | *                 | *   | ν<br>μΑ   |
| (Must use external buffer.)<br>External Reference Voltage Range<br>for Specified Linearity<br>External Reference Current Drain  | Ext. 2.5000V Ref   | 2.3            | 2.5                                       | 2.7<br>100  | *                          | *                 | *   | ν<br>μA   |
| $\begin{array}{c} \textbf{DIGITAL INPUTS} \\ \text{Logic Levels} \\ V_{IL} \\ V_{IH} \\ I_{IL} \\ I_{IH} \end{array}$   |  | -0.3<br>+2.0   |   | +0.8<br>V <sub>D</sub> +0.3V<br>±10<br>±10                                | *<br>*                     |                   | *<br>*<br>*   | ν<br>V<br>μΑ<br>μΑ  |
| DIGITAL OUTPUTS<br>Data Format<br>Data Coding<br>V <sub>OL</sub><br>V <sub>OH</sub><br>Leakage Current<br>Output Capacitance  | I <sub>SINK</sub> = 1.6mA<br>I <sub>SOURCE</sub> = 500μA<br>High-Z State,<br>V <sub>OUT</sub> = 0V to V <sub>DIG</sub><br>High-Z State | +4             |   |   | I 12 bits<br>t Binary<br>★ |                   | * * *   | V<br>V<br>μA<br>pF  |
| DIGITAL TIMING<br>Bus Access Time<br>Bus Relinquish Time  |  |                |   | 83<br>83  |                            |                   | *   | ns<br>ns  |

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# SPECIFICATIONS (CONT)

### ELECTRICAL

 $T_A = -40^{\circ}C$  to +85°C,  $f_S = 100$ kHz,  $V_{DIG} = V_{ANA} = +5V$ , using internal reference, unless otherwise specified.

|  |                            |                   | ADS7820P/U            |                     | ADS7820PB/UB |             |             |                    |
|--|----------------------------|-------------------|-----------------------|---------------------|--------------|-------------|-------------|--------------------|
| PARAMETER  | CONDITIONS                 | MIN               | ТҮР                   | MAX                 | MIN          | ТҮР         | MAX         | UNITS              |
| POWER SUPPLIES<br>Specified Performance  |                            |                   | _                     |                     |              |             |             |                    |
| V <sub>DIG</sub><br>V <sub>ANA</sub><br>+I <sub>DIG</sub><br>+I <sub>ANA</sub>   | Must be ≤ V <sub>ANA</sub> | +4.75<br>+4.75    | +5<br>+5<br>0.3<br>16 | +5.25<br>+5.25      | * *          | *<br>*<br>* | *           | V<br>V<br>mA<br>mA |
| Power Dissipation  | f <sub>S</sub> = 100kHz    |                   |                       | 100                 |              |             | *           | mW                 |
| TEMPERATURE RANGE         Specified Performance         Derated Performance         Storage         Thermal Resistance ( $\theta_{1A}$ ) |                            | -40<br>-55<br>-65 |                       | +85<br>+125<br>+150 | *<br>*<br>*  |             | *<br>*<br>* | °C<br>°C<br>°C     |
| Plastic DIP<br>SOIC  |                            |                   | 75<br>75              |                     |              | *           |             | °C/W<br>°C/W       |

NOTES: (1) LSB means Least Significant Bit. For the 12-bit, 0 to +5V input ADS7820, one LSB is 1.22mV. (2) Typical rms noise at worst case transitions and temperatures. (3) Adjustable to zero with external potentiometer as shown in Figure 4b. (4) Full scale error is the worst case of Full Scale untrimmed deviation from ideal last code transition divided by the transition voltage and includes the effect of offset error. (5) All specifications in dB are referred to a full-scale input. (6) Full-Power Bandwidth defined as Full-Scale input frequency at which Signal-to-(Noise + Distortion) degrades to 60dB, or 10 bits of accuracy. (7) Recovers to specified performance after 2 x FS input overvoltage.

#### **ABSOLUTE MAXIMUM RATINGS**

| Analog Inputs: V <sub>IN</sub> 0.7V to +V <sub>ANA</sub> -<br>REF+V <sub>ANA</sub> +0.3V to AGND2 -<br>CAPIndefinite Short to A<br>Momentary Short to | –0.3V<br>GND2   |
|---|---|
| Ground Voltage Differences: DGND, AGND1, AGND2<br>V <sub>ANA</sub>  | ±0.3V<br>7V<br>+0.3V<br>7V<br>+0.3V<br>+0.3V<br>165°C<br>25mW |

#### PACKAGE INFORMATION

| PRODUCT               | PACKAGE             | PACKAGE DRAWING<br>NUMBER <sup>(1)</sup> |
|-----------------------|---------------------|--|
| ADS7820P              | Plastic DIP         | 246                                      |
| ADS7820PB<br>ADS7820U | Plastic DIP<br>SOIC | 246<br>217                               |
| ADS7820UB             | SOIC                | 217                                      |

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

# ELECTROSTATIC DISCHARGE SENSITIVITY

Electrostatic discharge can cause damage ranging from performance degradation to complete device failure. Burr-Brown Corporation recommends that all integrated circuits be handled and stored using appropriate ESD protection methods.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet published specifications.

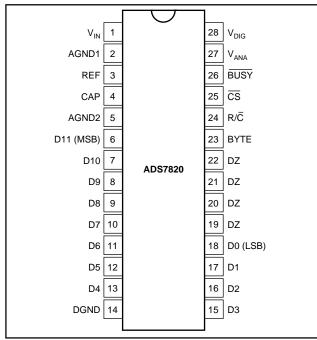
#### ORDERING INFORMATION

| PRODUCT   | MAXIMUM<br>LINEARITY<br>ERROR (LSB) | MINIMUM<br>SIGNAL-TO-<br>(NOISE +<br>DISTORTION)<br>RATIO (dB) | SPECIFICATION<br>TEMPERATURE<br>RANGE | PACKAGE     |
|-----------|-------------------------------------|--|---------------------------------------|-------------|
| ADS7820P  | ±1.0                                | 70   | -40°C to +85°C                        | Plastic DIP |
| ADS7820PB | ±0.5                                | 72   | -40°C to +85°C                        | Plastic DIP |
| ADS7820U  | ±1.0                                | 70   | -40°C to +85°C                        | SOIC        |
| ADS7820UB | ±0.5                                | 72   | -40°C to +85°C                        | SOIC        |



ADS7820

#### **PIN CONFIGURATION**



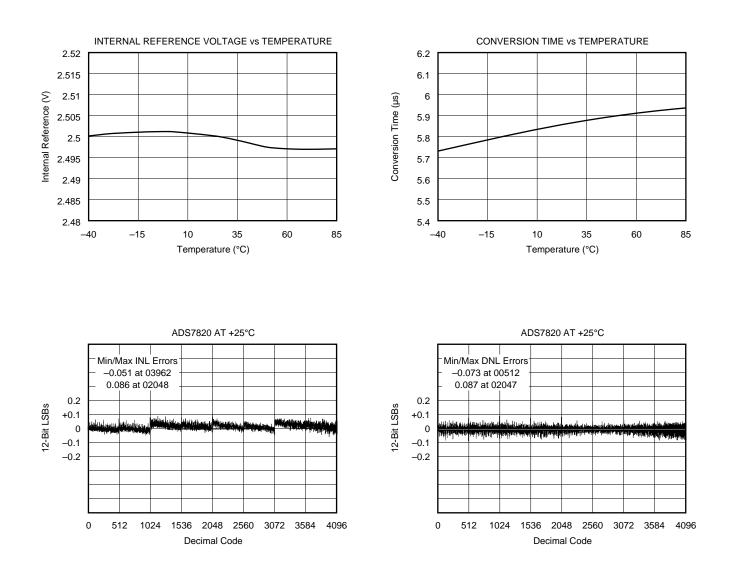
#### **PIN ASSIGNMENTS**

| PIN # | NAME             | DESCRIPTION   |
|-------|------------------|---|
| 1     | V <sub>IN</sub>  | Analog Input. Full-scale input range is 0 to +5V.   |
| 2     | AGND1            | Analog Ground. Used internally as ground reference point.   |
| 3     | REF              | Reference Input/Output. Outputs internal reference of +2.5V nominal. Can also be driven by external system reference. In both cases, connect to ground with a 2.2μF Tantalum capacitor.   |
| 4     | CAP              | Reference Buffer Capacitor. 2.2µF Tantalum to ground.   |
| 5     | AGND2            | Analog Ground.  |
| 6     | D11 (MSB)        | Data Bit 11. Most Significant Bit (MSB) of conversion results. Hi-Z state when $\overline{\text{CS}}$ is HIGH, or when R/ $\overline{\text{C}}$ is LOW.   |
| 7     | D10              | Data Bit 10. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.   |
| 8     | D9               | Data Bit 9. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 9     | D8               | Data Bit 8. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 10    | D7               | Data Bit 7. Hi-Z state when $\overline{\text{CS}}$ is HIGH, or when R/ $\overline{\text{C}}$ is LOW.  |
| 11    | D6               | Data Bit 6. Hi-Z state when $\overline{\text{CS}}$ is HIGH, or when R/ $\overline{\text{C}}$ is LOW.  |
| 12    | D5               | Data Bit 5. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 13    | D4               | Data Bit 4. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 14    | DGND             | Digital Ground.   |
| 15    | D3               | Data Bit 3. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 16    | D2               | Data Bit 2. Hi-Z state when $\overline{\text{CS}}$ is HIGH, or when R/ $\overline{\text{C}}$ is LOW.  |
| 17    | D1               | Data Bit 1. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 18    | D0 (LSB)         | Data Bit 0. Lease Significant Bit (LSB) of conversion results. Hi-Z state when $\overline{CS}$ is HIGH, or when $R/\overline{C}$ is LOW.  |
| 19    | DZ               | Data Zero. LOW when $\overline{CS}$ LOW and R/ $\overline{C}$ HIGH. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 20    | DZ               | Data Zero. LOW when $\overline{CS}$ LOW and R/ $\overline{C}$ HIGH. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 21    | DZ               | Data Zero. LOW when $\overline{CS}$ LOW and R/ $\overline{C}$ HIGH. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 22    | DZ               | Data Zero. LOW when $\overline{CS}$ LOW and R/ $\overline{C}$ HIGH. Hi-Z state when $\overline{CS}$ is HIGH, or when R/ $\overline{C}$ is LOW.  |
| 23    | BYTE             | Byte Select. With BYTE LOW, data will be output as indicated above, causing pin 6 (D11) to output the MSB, and pin 18 (D0) to output the LSB. Pins 19 to 22 will output LOWs. With BYTE HIGH, the top and bottom 8 bits of data will be switched, so that pin 6 outputs data bit 3, pin 9 outputs data bit 0 (LSB), pin 10 to 13 output LOWs, pin 15 outputs data bit 11 (MSB) and pin 22 outputs data bit 4.   |
| 24    | R/C              | Read/Convert input. With $\overline{CS}$ LOW, a falling edge on R/ $\overline{C}$ puts the internal sample/hold into the hold state and starts a conversion. With $\overline{CS}$ LOW, a rising edge on R/ $\overline{C}$ enables the output data bits.   |
| 25    | CS               | Chip Select. Internally OR'd with R/C. With R/C LOW, a falling edge on CS will initiate a conversion. With R/C HIGH, a falling edge on CS will enable the output data bits.   |
| 26    | BUSY             | Busy Output. Falls when a conversion is started, and remains LOW until the conversion is completed and the data is latched into the output register. With $\overline{CS}$ LOW and R/ $\overline{C}$ HIGH, output data will be valid when $\overline{BUSY}$ rises, so that the rising edge can be used to latch the data. $\overline{CS}$ or R/ $\overline{C}$ must be high when $\overline{BUSY}$ rises, or another conversion will start, without time for signal acquisition. |
| 27    | V <sub>ANA</sub> | Analog Supply Input. Nominally +5V. Connect directly to pin 28. Decouple to ground with 0.1µF ceramic and 10µF Tantalum capacitors.   |
| 28    | V <sub>DIG</sub> | Digital Supply Input. Nominally +5V. Connect directly to pin 27. Must be $\leq V_{ANA}$ .   |



# **TYPICAL PERFORMANCE CURVES**

At  $T_A = -40^{\circ}$ C to +85°C,  $f_S = 100$ kHz,  $V_{DIG} = V_{ANA} = +5$ V, using internal reference, unless otherwise specified.





# **BASIC OPERATION**

Figure 1 shows a basic circuit to operate the ADS7820 with a full parallel data output. Taking  $R/\overline{C}$  (pin 24) LOW for a minimum of 40ns (5.4µs max) will initiate a conversion. BUSY (pin 26) will go LOW and stay LOW until the conversion is completed and the output registers are updated. Data will be output in Straight Binary with the MSB on pin 6. BUSY going HIGH can be used to latch the data. All convert commands will be ignored while BUSY is LOW.

The ADS7820 will begin tracking the input signal at the end of the conversion. Allowing  $10\mu s$  between convert commands assures accurate acquisition of a new signal.

## **STARTING A CONVERSION**

The combination of  $\overline{CS}$  (pin 25) and R/ $\overline{C}$  (pin 24) LOW for a minimum of 40ns immediately puts the sample/hold of the ADS7820 in the hold state and starts conversion 'n'. BUSY (pin 26) will go LOW and stay LOW until conversion 'n' is completed and the internal output register has been updated. All new convert commands during BUSY LOW will be ignored.  $\overline{CS}$  and/or R/ $\overline{C}$  must go HIGH before BUSY goes HIGH or a new conversion will be initiated without sufficient time to acquire a new signal.

The ADS7820 will begin tracking the input signal at the end of the conversion. Allowing 10 $\mu$ s between convert commands assures accurate acquisition of a new signal. Refer to Table I for a summary of  $\overline{CS}$ ,  $R/\overline{C}$ , and  $\overline{BUSY}$  states and Figures 3 through 5 for timing diagrams.

 $\overline{\text{CS}}$  and  $\text{R}/\overline{\text{C}}$  are internally OR'd and level triggered. There is not a requirement which input goes LOW first when initiating a conversion. If, however, it is critical that  $\overline{\text{CS}}$  or  $\text{R}/\overline{\text{C}}$  initiates conversion 'n', be sure the less critical input is LOW at least 10ns prior to the initiating input.

To reduce the number of control pins,  $\overline{CS}$  can be tied LOW using  $R/\overline{C}$  to control the read and convert modes. However, the output will become active whenever  $R/\overline{C}$  goes HIGH. Refer to the **Reading Data** section.

| CS           | R/C  | BUSY | OPERATION  |  |  |
|--------------|--|------|--|--|--|
| 1            | Х  | Х    | None. Databus is in Hi-Z state.  |  |  |
| Ļ            | 0  | 1    | Initiates conversion "n". Databus remains in Hi-Z state.   |  |  |
| 0            | $\rightarrow$  | 1    | Initiates conversion "n". Databus enters Hi-Z state.   |  |  |
| 0            | 1  | Ŷ    | Conversion "n" completed. Valid data from conversion "n" on the databus.   |  |  |
| $\downarrow$ | 1  | 1    | Enables databus with valid data from conversion "n".   |  |  |
| $\downarrow$ | 1  | 0    | Enables databus with valid data from conversion "n-1" <sup>(1)</sup> . Conversion n in process.  |  |  |
| 0            | Ŷ  | 0    | Enables databus with valid data from conversion "n-1" <sup>(1)</sup> . Conversion "n" in process.  |  |  |
| 0            | 0  | Ŷ    | New conversion initiated without acquisition<br>of a new signal. Data will be invalid. $\overline{CS}$ and/or<br>$R/\overline{C}$ must be HIGH when $\overline{BUSY}$ goes HIGH. |  |  |
| Х            | Х  | 0    | New convert commands ignored. Conversion "n" in process.   |  |  |
|              | NOTE: (1) See Figures 2 and 3 for constraints on data valid from conversion "n-1". |      |  |  |  |

Table I. Control Line Functions for "Read" and "Convert".

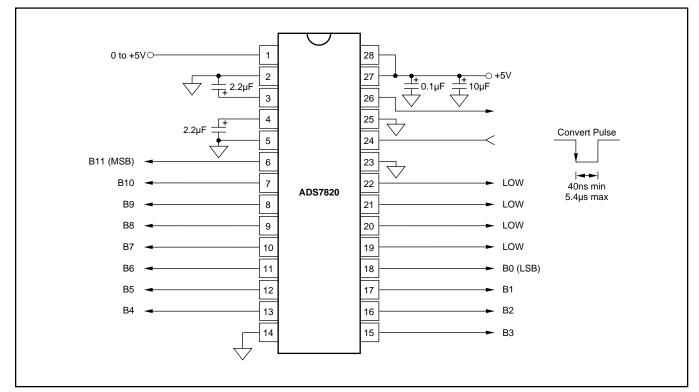


FIGURE 1. Basic Operation (Byte Low).

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## **READING DATA**

The ADS7820 outputs full or byte-reading parallel data in Straight Binary data output format. The parallel output will be active when  $R/\overline{C}$  (pin 24) is HIGH and  $\overline{CS}$  (pin 25) is LOW. Any other combination of  $\overline{CS}$  and  $R/\overline{C}$  will tri-state the parallel output. Valid conversion data can be read in a full parallel, 12-bit word or two 8-bit bytes on pins 6-13 and pins 15-22. BYTE (pin 23) can be toggled to read both bytes within one conversion cycle. Refer to Table II for ideal output codes and Figure 2 for bit locations relative to the state of BYTE.

|                                |              | DIGITAL OUTPUT<br>STRAIGHT BINARY |          |  |
|--------------------------------|--------------|-----------------------------------|----------|--|
| DESCRIPTION                    | ANALOG INPUT | BINARY CODE                       | HEX CODE |  |
| Full Scale Range               | 0 to +5V     |                                   |          |  |
| Least Significant<br>Bit (LSB) | 1.22mV       |                                   |          |  |
| Full Scale                     | 4.99878V     | 1111 1111 1111                    | FFF      |  |
| Midscale                       | 2.5V         | 1000 0000 0000                    | 800      |  |
| One LSB below<br>Midscale      | 2.49878V     | 0111 1111 1111                    | 7FF      |  |
| Zero Scale                     | 0V           | 0000 0000 0000                    | 0        |  |

Table II. Ideal Input Voltages and Output Codes.

### PARALLEL OUTPUT (After a Conversion)

After conversion 'n' is completed and the output registers have been updated, <u>BUSY</u> (pin 26) will go HIGH. Valid data from conversion 'n' will be available on D11-D0 (pin 6-13 and 15-18 when BYTE is LOW). <u>BUSY</u> going HIGH can be used to latch the data. Refer to Table III and Figures 3 and 5 for timing specifications.

### PARALLEL OUTPUT (During a Conversion)

After conversion 'n' has been initiated, valid data from conversion 'n-1' can be read and will be valid up to  $16\mu s$ after the start of conversion 'n'. Do not attempt to read data from  $16\mu s$  after the start of conversion 'n' until  $\overline{BUSY}$  (pin 26) goes HIGH; this may result in reading invalid data. Refer to Table III and Figures 3 and 5 for timing specifications.

**Note!** For the best possible performance, data should not be read during a conversion. The switching noise of the asynchronous data transfer can cause digital feedthrough degrading the converter's performance.

The number of control lines can be reduced by tieing  $\overline{CS}$  LOW while using R/ $\overline{C}$  to initiate conversions and activate the output mode of the converter. See Figure 3.

| SYMBOL                           | DESCRIPTION                                    | MIN | ТҮР | МАХ     | UNITS    |
|----------------------------------|--|-----|-----|---------|----------|
| t <sub>1</sub>                   | Convert Pulse Width                            | 40  |     | 5400    | ns       |
| t <sub>2</sub>                   | Data Valid Delay after R/C LOW                 |     |     | 8       | μs       |
| t <sub>3</sub><br>t <sub>4</sub> | BUSY Delay from R/C LOW<br>BUSY LOW            |     |     | 65<br>8 | ns<br>μs |
| t <sub>5</sub>                   | BUSY Delay after<br>End of Conversion          |     | 220 |         | ns       |
| t <sub>6</sub>                   | Aperture Delay                                 |     | 40  |         | ns       |
| t <sub>7</sub>                   | Conversion Time                                |     | 7.6 | 8       | μs       |
| t <sub>8</sub>                   | Acquisition Time                               |     |     | 2       | μs       |
| t <sub>9</sub>                   | Bus Relinquish Time                            | 10  | 35  | 83      | ns       |
| t <sub>10</sub>                  | BUSY Delay after Data Valid                    | 50  | 200 |         | ns       |
| t <sub>11</sub>                  | Previous Data Valid<br>after R/C LOW           |     | 7.4 |         | μs       |
| t <sub>7</sub> + t <sub>6</sub>  | Throughput Time                                |     | 9   | 10      | μs       |
| t <sub>12</sub>                  | $R/\overline{C}$ to $\overline{CS}$ Setup Time | 10  |     |         | ns       |
| t <sub>13</sub>                  | Time Between Conversions                       | 10  |     |         | μs       |
| t <sub>14</sub>                  | Bus Access Time<br>and BYTE Delay              | 10  |     | 83      | ns       |

TABLE III. Conversion Timing.

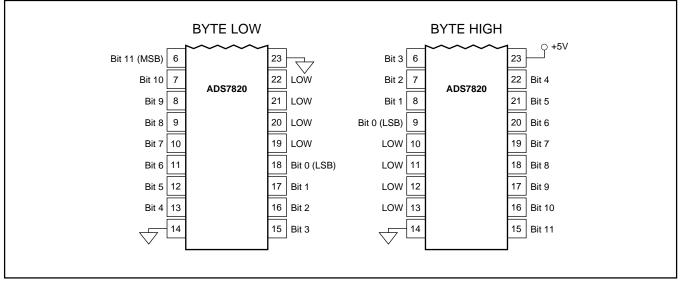


FIGURE 2. Bit Locations Relative to State of BYTE (pin 23).

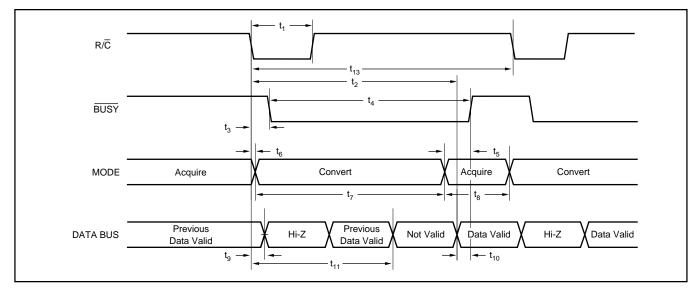


FIGURE 3. Conversion Timing with Outputs Enabled after Conversion ( $\overline{CS}$  Tied LOW.)

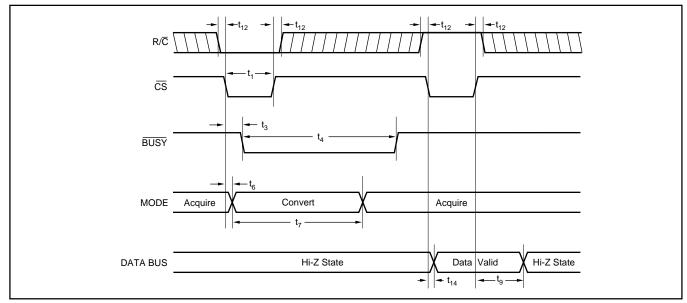


FIGURE 4. Using  $\overline{CS}$  to Control Conversion and Read Timing.

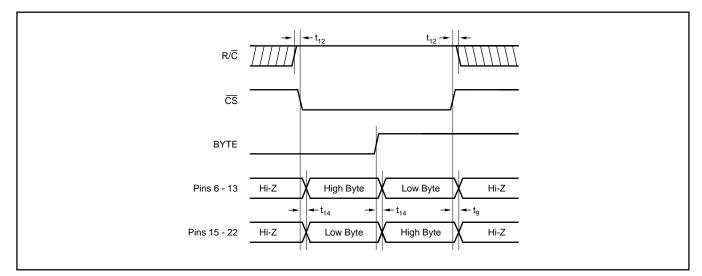


FIGURE 5. Using  $\overline{\text{CS}}$  and BYTE to Control Data Bus.



#### **INPUT RANGE**

The ADS7820 offers a standard 0V to 5V input range. Figure 6 shows the required circuit connections for the ADS7820 with and without the gain adjustment hardware. Adjustments for offset and gain are described in the calibration section of this data sheet.

# CALIBRATION

The ADS7820 can be trimmed in hardware or software. There is no external, offset adjustment. If offset adjustment is required, an op amp featuring an offset trim pin should be used to drive the ADS7820. The offset should be trimmed before the gain since the offset directly affects the gain. To achieve optimum performance, several iterations may be required.

### GAIN ADJUSTMENT

To calibrate the gain of the ADS7820, a 576k $\Omega$  resistor must be tied between the REF pin and a 5V potentiometer (see Figure 6b). The calibration range is  $\pm 15mV$  for the gain.

### REFERENCE

The ADS7820 can operate with its internal 2.5V reference or an external reference. By applying an external reference to pin 3, the internal reference can be bypassed. The reference voltage at REF is buffered internally with the output on CAP (pin 4).

The internal reference has an 8 ppm/°C drift (typical) and accounts for approximately 20% of the full scale error (FSE =  $\pm 0.5\%$  for low grade,  $\pm 0.25\%$  for high grade).

### REF

REF (pin 3) is an input for an external reference or the output for the internal 2.5V reference. A  $2.2\mu$ F capacitor should be connected as close to the REF pin as possible. The capacitor and the output resistance of REF create a low pass filter to bandlimit noise on the reference. Using a smaller value capacitor will introduce more noise to the reference degrading the SNR and SINAD. The REF pin should not be used to drive external AC or DC loads.

The range for the external reference is 2.3V to 2.7V and determines the actual LSB size. Increasing the reference voltage will increase the full scale range and the LSB size of the converter which can improve the SNR.

#### CAP

CAP (pin 4) is the output of the internal reference buffer. A 2.2 $\mu$ F capacitor should be placed as close to the CAP pin as possible to provide optimum switching currents for the CDAC throughout the conversion cycle and compensation for the output of the internal buffer. Using a capacitor any smaller than 1 $\mu$ F can cause the output buffer to oscillate and may not have sufficient charge for the CDAC. Capacitor values larger than 2.2 $\mu$ F will have little affect on improving performance.

The output of the buffer is capable of driving up to 2mA of current to a DC load. DC loads requiring more than 2mA of current from the CAP pin will begin to degrade the linearity of the ADS7820. Using an external buffer will allow the internal reference to be used for larger DC loads and AC loads. Do not attempt to directly drive an AC load with the output voltage on CAP. This will cause performance degradation of the converter.

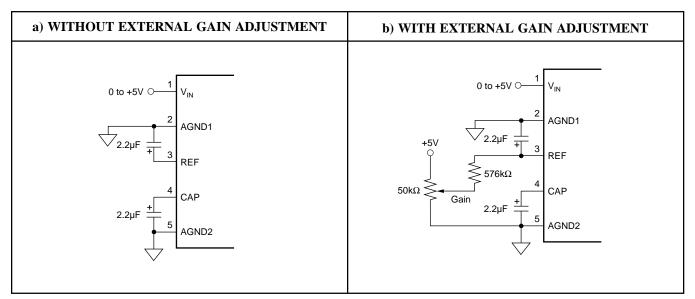


FIGURE 6. Circuit Diagram With and Without External Gain Adjustment.

# LAYOUT

### POWER

For optimum performance, tie the analog and digital power pins to the same +5V power supply and tie the analog and digital grounds together. As noted in the electrical specifications, the ADS7820 uses 90% of its power for the analog circuitry. The ADS7820 should be considered as an analog component.

The +5V power for the A/D should be separate from the +5V used for the system's digital logic. Connecting  $V_{DIG}$  (pin 28) directly to a digital supply can reduce converter performance due to switching noise from the digital logic. For best performance, the +5V supply can be produced from whatever analog supply is used for the rest of the analog signal conditioning. If +12V or +15V supplies are present, a simple +5V regulator can be used. Although it is not suggested, if the digital supply must be used to power the converter, be sure to properly filter the supply. Either using a filtered digital supply or a regulated analog supply, both  $V_{DIG}$  and  $V_{ANA}$  should be tied to the same +5V source.

### GROUNDING

Three ground pins are present on the ADS7820. DGND is the digital supply ground. AGND2 is the analog supply ground. AGND1 is the ground which all analog signals internal to the A/D are referenced. AGND1 is more susceptible to current induced voltage drops and must have the path of least resistance back to the power supply.

All the ground pins of the A/D should be tied to the analog ground plane, separated from the system's digital logic ground, to achieve optimum performance. Both analog and digital ground planes should be tied to the "system" ground as near to the power supplies as possible. This helps to prevent dynamic digital ground currents from modulating the analog ground through a common impedance to power ground.

### SIGNAL CONDITIONING

The FET switches used for the sample hold on many CMOS A/D converters release a significant amount of charge injection which can cause the driving op amp to oscillate. The FET switch on the ADS7820, compared to the FET switches on other CMOS A/D converters, releases 5%-10% of the charge. There is also a resistive front end which attenuates any charge which is released. The end result is a minimal requirement for the anti-alias filter on the front end. Any op amp sufficient for the signal in an application will be sufficient to drive the ADS7820.

#### **INTERMEDIATE LATCHES**

The ADS7820 does have tri-state outputs for the parallel port, but intermediate latches should be used if the bus will be active during conversions. If the bus is not active during conversion, the tri-state outputs can be used to isolate the A/D from other peripherals on the same bus. Tri-state outputs can also be used when the A/D is the only peripheral on the data bus.

Intermediate latches are beneficial on any monolithic A/D converter. The ADS7820 has an internal LSB size of  $610\mu$ V. Transients from fast switching signals on the parallel port, even when the A/D is tri-stated, can be coupled through the substrate to the analog circuitry causing degradation of converter performance. The effects of this phenomenon will be more obvious when using the pin-compatible ADS7821 or any of the other 16-bit converters in the ADS Family. This is due to the smaller internal LSB size of  $38\mu$ V.

ADS7820